Docket No.: JCLA8104-D
Date: October 31, 2003

COMMISSIONER FOR PATENTS P.O. BOX 1450 ALEXANDRIA, VA 22313-1450

ATTENTION: APPLICATION BRANCH

Sir:

This is a request for filing a continuation application under 37 CFR 1.53 (b) as a divisional application of prior application No.10/034,326 filed on December 28, 2001.

Prior application information: Examiner: WONG, EDNA ; Group Art Unit: 1753

The entire disclosure of the prior application, from which an oath or declaration is supplied herewith as indicated below, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference.

Transmitted herewith for filing is the patent application of

Inventor(s): CHEN, PHILLIP CHUNG-HWEI;

For: LOW-LEAD-CONTENT PLATING PROCESS

Enclosed are:

- (X) Specification in FIFTEEN (15) pages.
- (X) THREE (3) sheets of Drawings.
- (X) Preliminary Amendment.
- (X) A copy of Declaration and Power of Attorney from the prior application is enclosed.
- (X) Applicant claims small entity status. See 37 CFR 1.27.
- (X) Return prepaid postcard.

CLAIMS AS FILED				
FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee		# 5474 to 1 1 1 1 1	\$ 385	\$ 385
Total Claims	5 - 20 =	0 ×	\$ 9	\$ 0
Independent Claims	1 - 3 =	0 ×	\$ 43	\$ 0
If application contains any multiple dependent claims(s), then add			\$ 145	\$ 0
For a Small Entity:	TOTAL FILING FEE			\$ 385

- (X) A check in the amount of $\frac{385}{100}$ to cover the filing fee is enclosed.
- (X) The commissioner is authorized to charge any additional necessary fee to Account No. 50-0710 (Order No. JCLA8104-D). A duplicate copy of this sheet is enclosed.

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CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : JCLA8104-D

Inventor(s) : PHILLIP CHUNG-HWEI CHEN;

For : LOW-LEAD-CONTENT PLATING PROCESS

"Express Mail"

Mailing Label No. : EV 300987255 US

Date of Deposit :

: October 31, 2003

I hereby certify that the accompanying

Transmittal in Duplicate; Specification in <u>15</u> page(s); <u>3</u> sheets of drawing(s); Copy of Declaration and Power of Attorney from prior application; Preliminary Amendment; Checks for Filing Fee(s); Return Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 on the date indicated above and are addressed to the Commissioner for Patents, P.O. BOX 1450, Alexandria, VA 22313-1450

Michelle Chang